300mA Low Dropout Linear Regulator

FEATURES

- Low Dropout Voltage of 470mV at 300mA Output Current (3.0V Output Version).
- Guaranteed 300mA Output Current.
- Maximum Input Voltage is 8V
- Low Ground Current at 55μA.
- 2% Accuracy Output Voltage of 1.5V/1.8V/ 2.0V /2.5V /2.7V/ 3.0V/ 3.3V/ 3.5V/ 3.7V/ 3.8V/ 5.0V/ 5.2V.
- Needs only 1μF for Stability.
- Current and Thermal Limiting.

APPLICATIONS

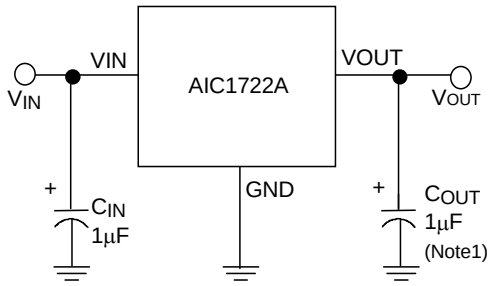
- Voltage Regulator for CD-ROM Drivers.
- Voltage Regulator for LAN Cards.
- Voltage Regulator for Microprocessor.
- Wireless Communication Systems.
- Battery Powered Systems.

DESCRIPTION

The AIC1722A is a 3-pin low dropout linear regulator. The superior characteristics of the AIC1722A include zero base current loss, very low dropout voltage, and 2% accuracy output voltage. Typical ground current remains approximately 55μA, from no load to maximum loading conditions. Dropout voltage at 300mA output current is exceptionally low. Output current limiting and thermal limiting are built in to provide maximal protection to the AIC1722A against fault conditions.

The AIC1722A comes in the popular 3-pin SOT-89, TO-92 and SOT-23 packages.

TYPICAL APPLICATION CIRCUIT



Low Dropout Linear Regulator

ORDERING INFORMATION

AIC1722A-XXXXX XX

- PACKING TYPE
  - TR: REEL
  - BG: BAG
- PACKAGE TYPE
  - U: SOT-23
  - XA: SOT-89
  - XT: SOT-89
  - ZT: TO-92
  - ZL: TO-92
- P: Lead Free Commercial
  G: Green Package
- OUTPUT VOLTAGE
  - 15: 1.5V
  - 18: 1.8V
  - 20: 2.0V
  - 25: 2.5V
  - 27: 2.7V
  - 30: 3.0V
  - 33: 3.3V
  - 35: 3.5V
  - 37: 3.7V
  - 38: 3.8V
  - 50: 5.0V
  - 52: 5.2V

Example: AIC1722A-18PXATR

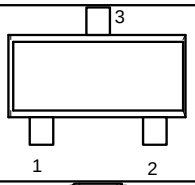
→ 1.8V Version, in SOT-89 Package & Tape & Reel Packing Type(lead free)

AIC1722A-18GXATR

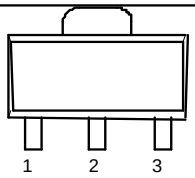
→ 1.8V Version, in SOT-89 Lead Free Package & Tape & Reel Packing Type (green)

PIN CONFIGURATION

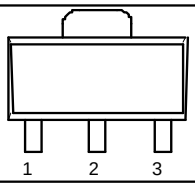
SOT-23 (U)
TOP VIEW
1: GND
2: VOUT
3: VIN



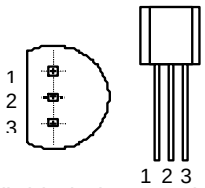
SOT-89 (XA)
TOP VIEW
1: GND
2. VIN
3. VOUT



SOT-89 (XT)
TOP VIEW
1: VOUT
2. GND
3. VIN

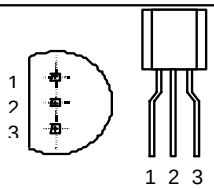


TO-92 (ZTBG)
TOP VIEW
1: GND
2. VIN
3. VOUT



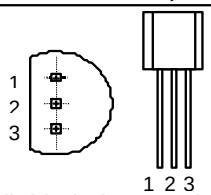
* Straight lead option available in bag packing type only.
* Refer to physical dimensions for lead pitch.

TO-92 (ZTTR)
TOP VIEW
1: GND
2. VIN
3. VOUT



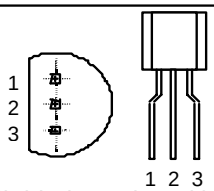
* Formed lead option available in reel packing type.
* Refer to physical dimensions for lead pitch.

TO-92 (ZLBG)
TOP VIEW
1: VIN
2. GND
3. VOUT



* Straight lead option available in bag packing type only.
* Refer to physical dimensions for lead pitch.

TO-92 (ZLBG)
TOP VIEW
1: VIN
2. GND
3. VOUT



* Formed lead option available in reel packing type.
* Refer to physical dimensions for lead pitch.

- **SOT-23 MARKING**

Part No.	PU	GU	Part No.	PU	GU
AIC1722A-15XU	BN15P	BN15G	AIC1722A-33XU	BN33P	BN33G
AIC1722A-18XU	BN18P	BN18G	AIC1722A-35XU	BN35P	BN35G
AIC1722A-20XU	BN20P	BN20G	AIC1722A-37XU	BN37P	BN37G
AIC1722A-25XU	BN25P	BN25G	AIC1722A-38XU	BN38P	BN38G
AIC1722A-27XU	BN27P	BN27G	AIC1722A-50XU	BN50P	BN50G
AIC1722A-30XU	BN30P	BN30G	AIC1722A-52XU	BN52P	BN52G

- **SOT-89 MARKING**

Part No.	PXA	GXA	Part No.	PXT	GXT
AIC1722A-15XXA	AL15P	AL15G	AIC1722A-15XXT	BA15P	BA15G
AIC1722A-18XXA	AL18P	AL18G	AIC1722A-18XXT	BA18P	BA18G
AIC1722A-20XXA	AL20P	AL20G	AIC1722A-20XXT	BA20P	BA20G
AIC1722A-25XXA	AL25P	AL25G	AIC1722A-25XXT	BA25P	BA25G
AIC1722A-27XXA	AL27P	AL27G	AIC1722A-27XXT	BA27P	BA27G
AIC1722A-30XXA	AL30P	AL30G	AIC1722A-30XXT	BA30P	BA30G
AIC1722A-33XXA	AL33P	AL33G	AIC1722A-33XXT	BA33P	BA33G
AIC1722A-35XXA	AL35P	AL35G	AIC1722A-35XXT	BA35P	BA35G
AIC1722A-37XXA	AL37P	AL37G	AIC1722A-37XXT	BA37P	BA37G
AIC1722A-38XXA	AL38P	AL38G	AIC1722A-38XXT	BA38P	BA38G
AIC1722A-50XXA	AL50P	AL50G	AIC1722A-50XXT	BA50P	BA50G
AIC1722A-52XXA	AL52P	AL52G	AIC1722A-52XXT	BA52P	BA52G

■ ABSOLUTE MAXIMUM RATINGS

Input Supply Voltage ..... -0.3~8V

Operating Temperature Range ..... -40°C~ 85°C

Junction Temperature ..... 125°C

Storage Temperature Range ..... -65°C~150°C

Lead Temperature (Soldering. 10sec) ..... 260°C

Thermal Resistance Junction to Case SOT-23.....130°C /W

SOT-89.....30°C /W

TO-92.....120°C /W

Thermal Resistance Junction to Ambient SOT-23.....180°C /W

(Assume no ambient airflow, no heatsink) SOT-89..... 160°C /W

TO-92.....150°C /W

Absolute Maximum Ratings are those values beyond which the life of a device may be impaired.

TEST CIRCUIT

Refer to the TYPICAL APPLICATION CIRCUIT.

ELECTRICAL CHARACTERISTICS (T_A=25°C, C_{IN}=1μF, C_{OUT}=1μF, unless otherwise specified.) (Note 2)

PARAMETER	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Output Voltage	V_{IN}=8V, No Load		-2		+2	%
Line Regulation	I_L=1mA,					mV
	1.4V≤V_{OUT}≤3.2V	V_{IN}=4V~8V		3	10	
	3.3V≤V_{OUT}≤5.2V	V_{IN}=5.5V~8V		3	15	
Load Regulation (Note 3)	I_L=0.1~300mA					mV
	1.4V≤V_{OUT}≤3.9V	V_{IN}=5V		7	20	
	4.0V≤V_{OUT}≤5.2V	V_{IN}=7V		15	40	
Current Limit (Note 4)	V_{IN}=7V, V_{OUT}=0V		300			mA
Dropout Voltage (Note 5)	I_L=300mA	4.0V≤V_{OUT}≤5.2V		400	500	mV
		3.0V≤V_{OUT}≤3.9V		470	570	
		2.5V≤V_{OUT}≤2.9V		570	670	
		2.0V≤V_{OUT}≤2.4V		800	900	
		1.4V≤V_{OUT}≤1.9V		1260	1360	
Ground Current	I_O=0.1mA~I_{MAX}					μA
	1.4V≤V_{OUT}≤3.9V	V_{IN}=5~8V		55	80	
	4.0V≤V_{OUT}≤5.2V	V_{IN}=7~8V		55	80	
Thermal Shutdown Hysteresis	Guaranteed by design			20		ºC

Note 1: To avoid output oscillation, aluminum electrolytic output capacitor is recommended and ceramic capacitor is not suggested.

Note 2: Specifications are production tested at T_A =25°C. Specifications over the -40°C to 85°C operating temperature range are assured by design, characterization and correlation with Statistical Quality Controls (SQC).

Note 3: Regulation is measured at constant junction temperature, using pulse testing with a low ON time.

Note 4: Current limit is measured by pulsing a short time.

Note 5: Dropout voltage is defined as the input to output differential at which the output voltage drops 100mV below the value measured with a 1V differential.

TYPICAL PERFORMANCE CHARACTERISTICS

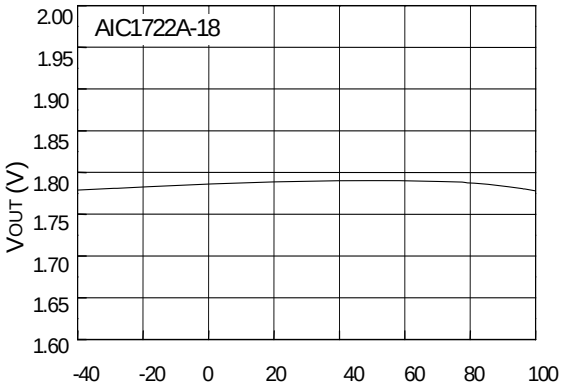


Fig. 1 V_{OUT} vs. Temperature

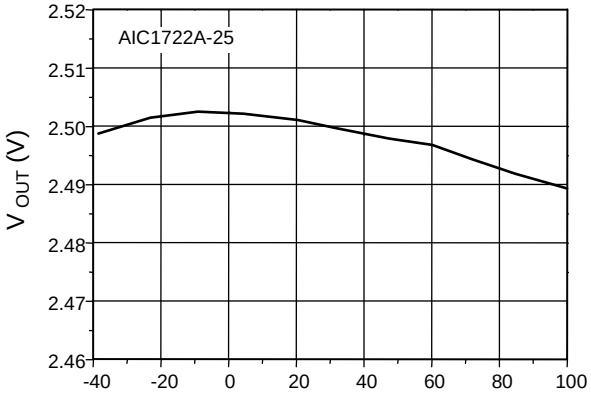


Fig. 2 V_{OUT} vs. Temperature

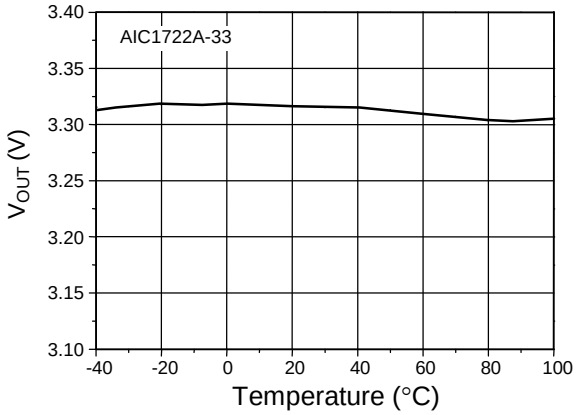


Fig. 3 V_{OUT} vs. Temperature

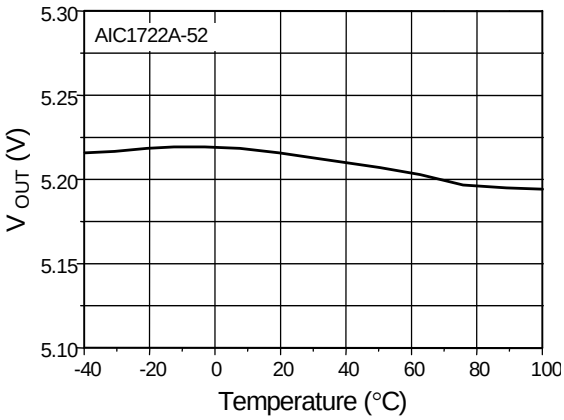


Fig. 4 V_{OUT} vs. Temperature

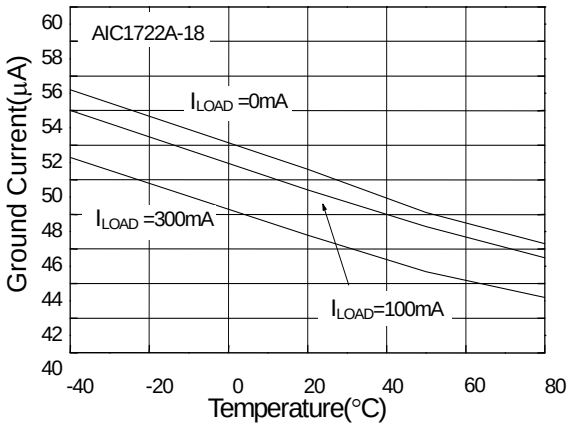


Fig. 5 Ground Current vs. Temperature

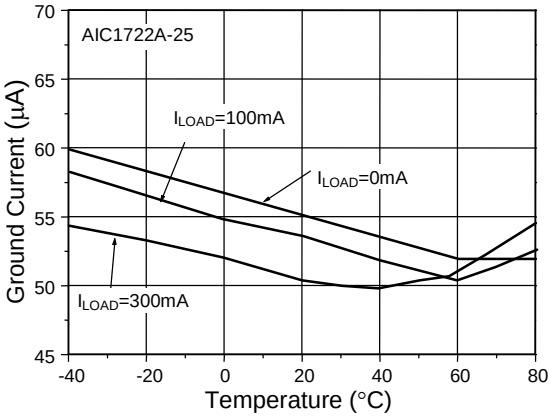


Fig. 6 Ground Current vs. Temperature

TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

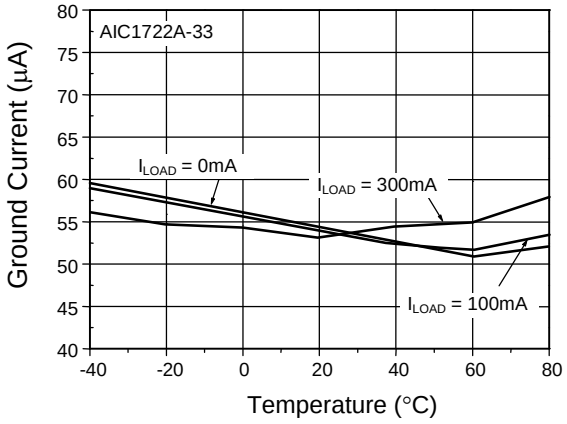


Fig. 7 Ground Current vs. Temperature

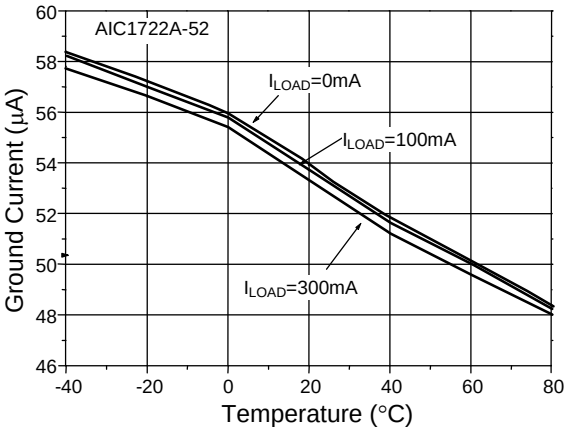


Fig. 8 Ground Current vs. Temperature

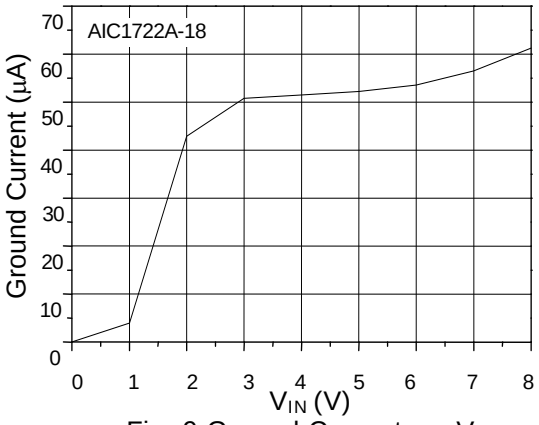


Fig. 9 Ground Current vs. V_{IN}

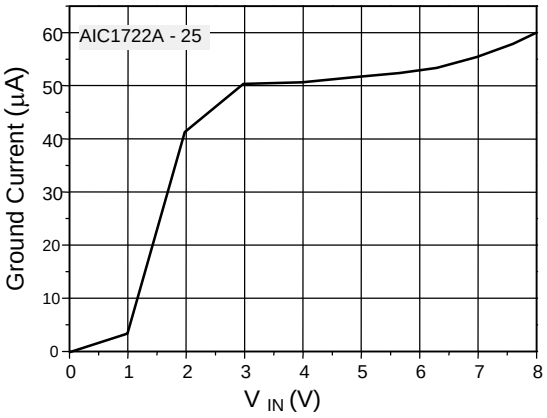


Fig. 10 Ground Current vs. V_{IN}

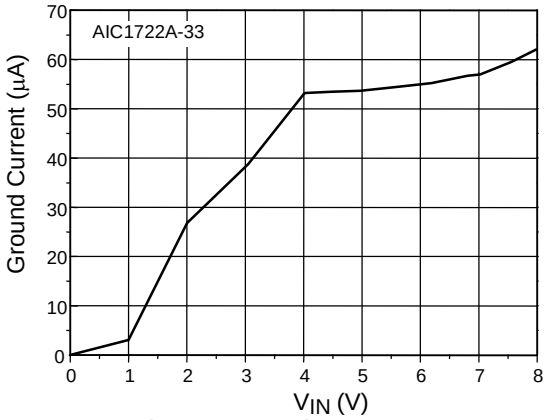


Fig. 11 Ground Current vs. V_{IN}

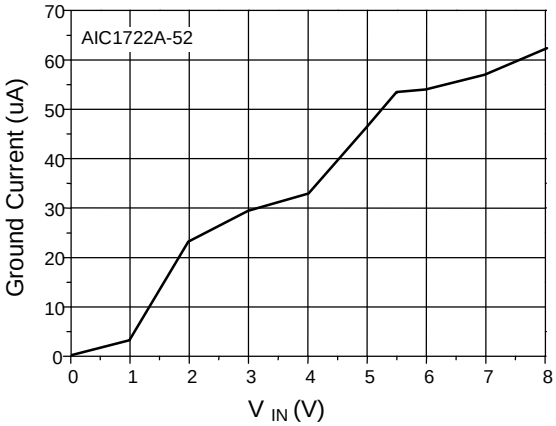


Fig.12 Ground Current vs. V_{IN}

TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

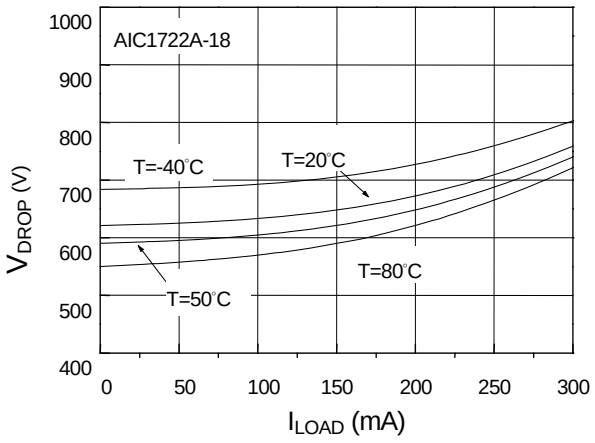


Fig. 13 V_{DROP} vs. I_{LOAD}

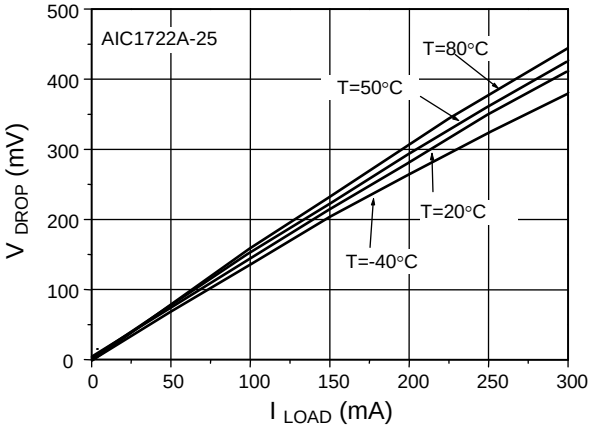


Fig. 14 V_{DROP} vs. I_{LOAD}

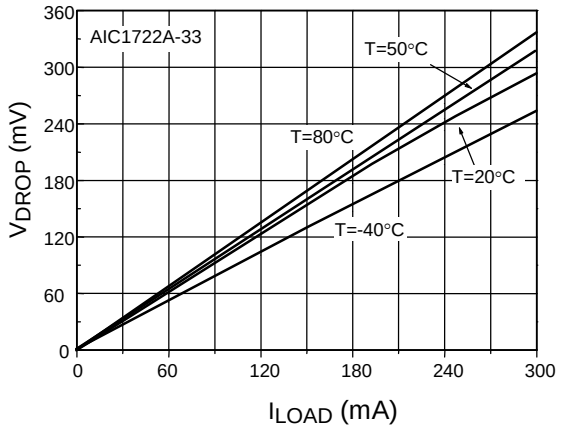


Fig. 15 V_{DROP} vs. I_{LOAD}

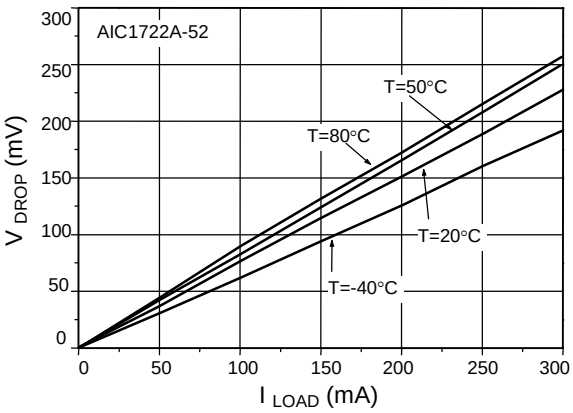


Fig. 16 V_{DROP} vs. I_{LOAD}

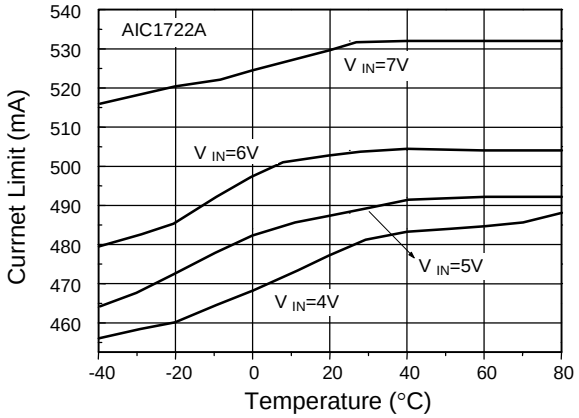
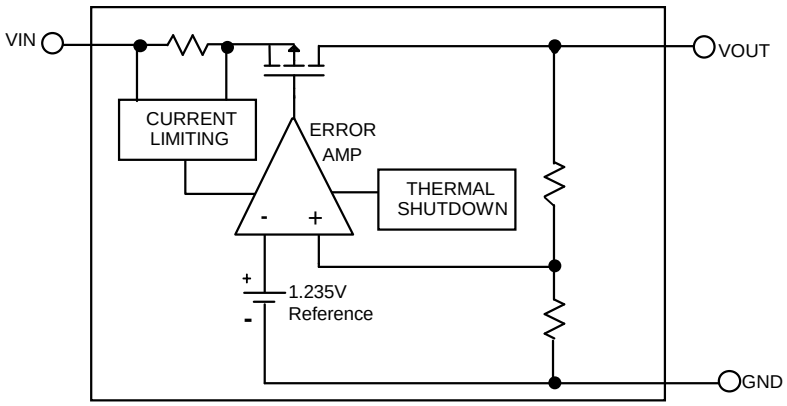


Fig. 17 Current Limit vs. Temperature

BLOCK DIAGRAM



PIN DESCRIPTIONS

VOUT PIN - Output pin.

GND PIN - Power GND.

VIN PIN - Power Supply Input.

APPLICATION INFORMATION

INPUT-OUTPUT CAPACITORS

Linear regulators require input and output capacitors to maintain stability. Input capacitor at 1μF with 1uF aluminum electrolytic output capacitor is recommended.

POWER DISSIPATION

The AIC1722A obtains thermal-limiting circuitry, which is designed to protect the device against overload condition. For continuous load condition, maximum rating of junction temperature must not be exceeded. It is important to pay more attention in thermal resistance. It includes junction to case, junction to ambient. The maximum power dissipation of AIC1722A depends on the thermal resistance of its case and circuit board, the temperature difference between the die junction and ambient air, and the rate of airflow. The rate of temperature rise is greatly affected by the mounting pad configuration on the PCB, the board material, and the ambient temperature. When the IC mounting with good thermal conductivity is used, the junction temperature will be low even when large power dissipation applies.

The power dissipation across the device is

$P = I_{OUT} (V_{IN}-V_{OUT})$.

The maximum power dissipation is:

$$P_{MAX} = \frac{(T_{J\text{-}max} - T_A)}{R\theta_{JA}}$$

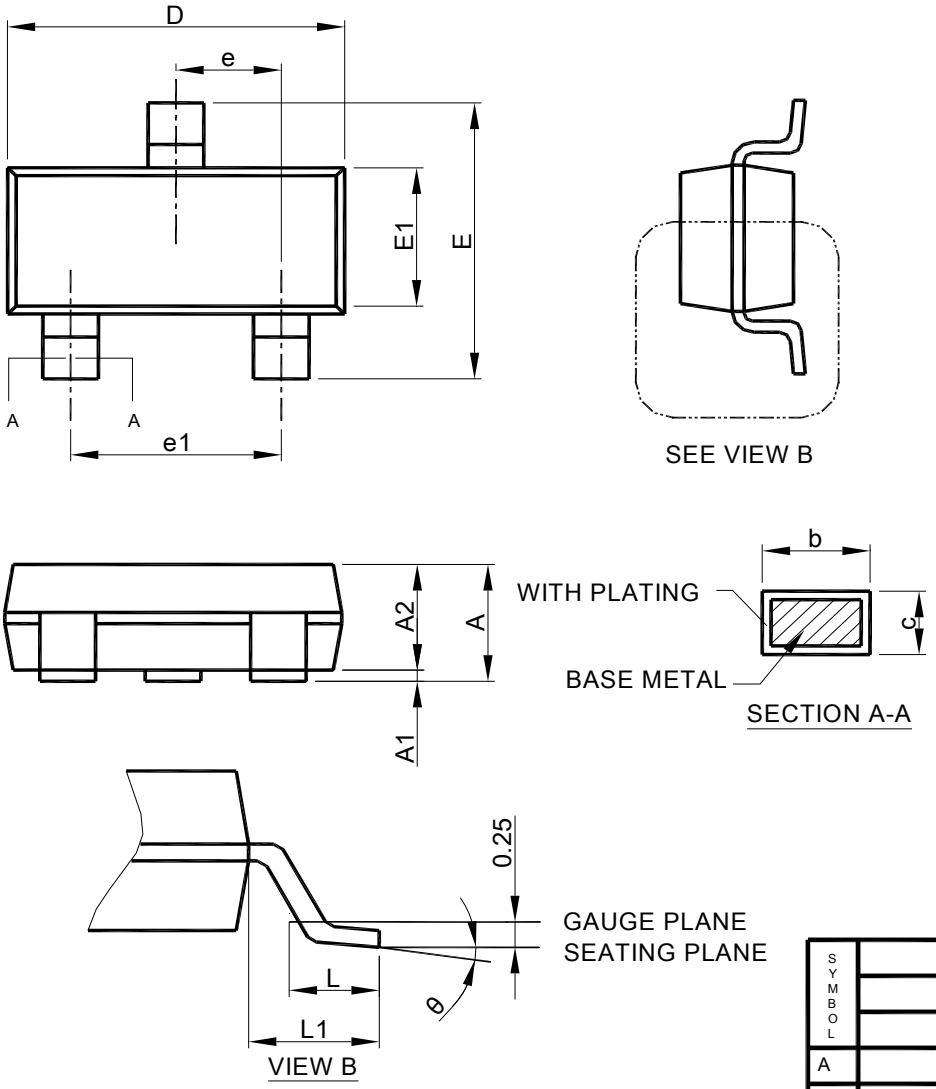
Where $T_{J\text{-}max}$ is the maximum allowable junction temperature (125°C), and T_A is the ambient temperature suitable in application.

As a general rule, the lower temperature is, the better reliability of the device is. So the PCB mounting pad should provide maximum thermal conductivity to maintain low device temperature.

GND pin performs a dual function for providing an electrical connection to ground and channeling heat away. Therefore, connecting the GND pin to ground with a large pad or ground plane would increase the power dissipation and reduce the device temperature.

PHYSICAL DIMENSIONS (unit: mm)

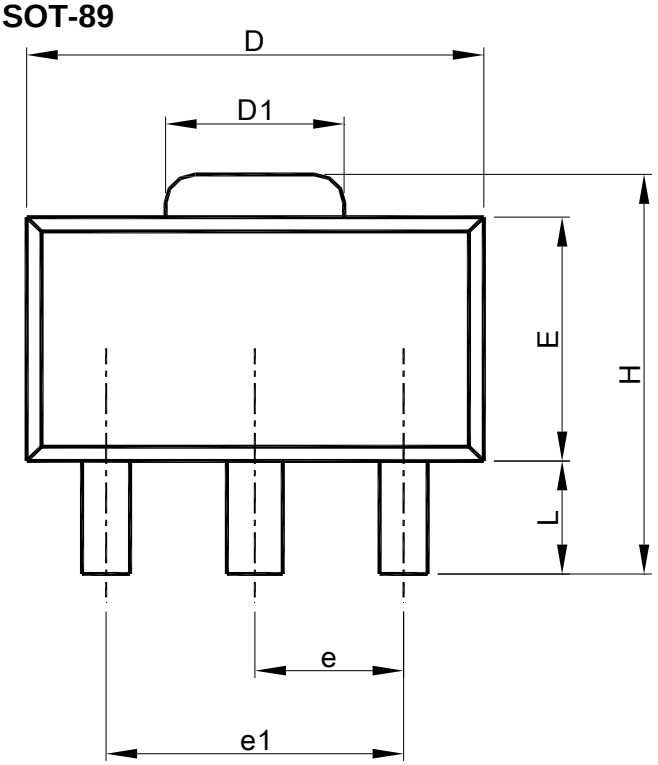
- **SOT-23**

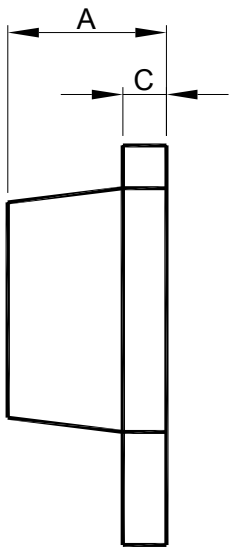


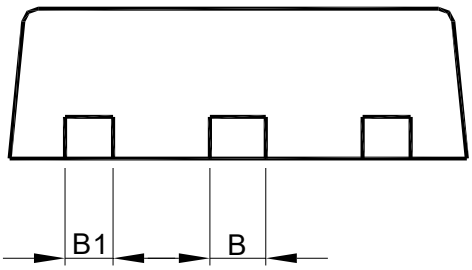
SYMBOL	SOT-23	
	MILLIMETERS	
	MIN.	MAX.
A	0.95	1.45
A1	0.00	0.15
A2	0.90	1.30
b	0.30	0.50
c	0.08	0.22
D	2.80	3.00
E	2.60	3.00
E1	1.50	1.70
e	0.95 BSC	
e1	1.90 BSC	
L	0.30	0.60
L1	0.60 REF	
θ	0°	8°

Note: 1. Refer to JEDEC MO-178.
2. Dimension "D" does not include mold flash, protrusions or gate burrs. Mold flash, protrusion or gate burrs shall not exceed 10 mil per side.
3. Dimension "E1" does not include inter-lead flash or protrusions.
4. Controlling dimension is millimeter, converted inch dimensions are not necessarily exact.

- **SOT-89**



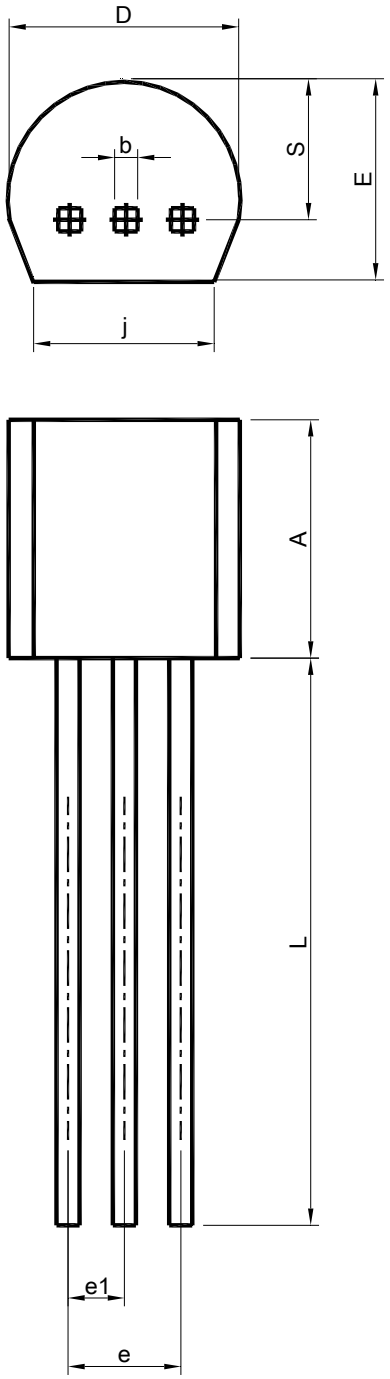




SYMBOL	SOT-89	
	MILLIMETERS	
	MIN.	MAX.
A	1.40	1.60
B	0.44	0.56
B1	0.36	0.48
C	0.35	0.44
D	4.40	4.60
D1	1.50	1.83
E	2.29	2.60
e	1.50 BSC	
e1	3.00 BSC	
H	3.94	4.25
L	0.89	1.20

Note: 1. Refer to JEDEC TO-243AA.
2. Dimension "D" does not include mold flash, protrusions or gate burrs. Mold flash, protrusion or gate burrs shall not exceed 6 mil per side.
3. Dimension "E" does not include inter-lead flash or protrusions.
4. Controlling dimension is millimeter, converted inch dimensions are not necessarily exact.

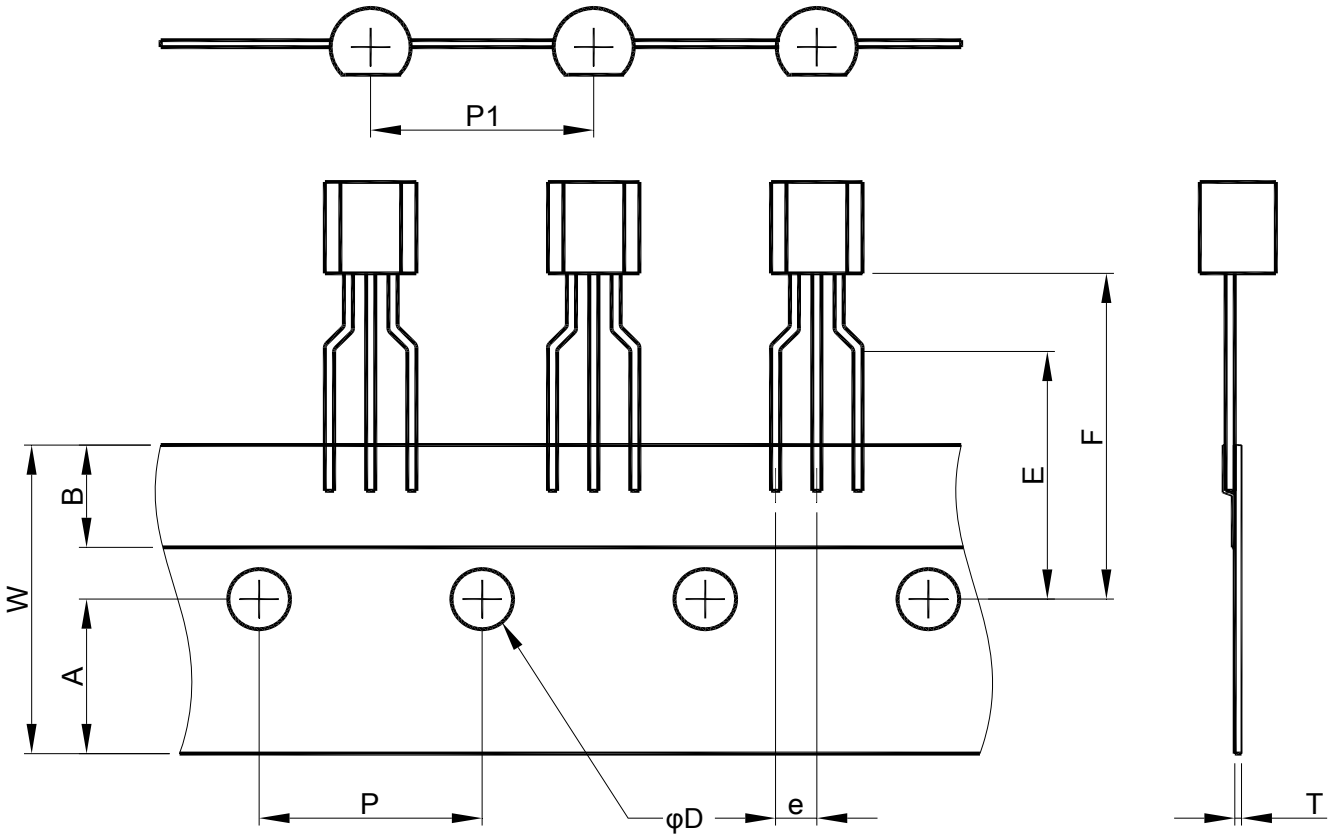
- **TO-92 (Straight lead option available in Bag packing type only)**



SYMBOL	TO-92	
	MILLIMETERS	
	MIN.	MAX.
A	4.32	5.33
b	0.36	0.47
D	4.45	5.20
E	3.18	4.19
e	2.42	2.66
e1	1.15	1.39
j	3.43	
L	12.70	
S	2.03	2.66

Note: 1. Refer to JEDEC TO-226.
2. Dimension "D" does not include mold flash, protrusions or gate burrs. Mold flash, protrusion or gate burrs shall not exceed 6 mil per side .
3. Dimension "A" does not include inter-lead flash or protrusions.
4. Controlling dimension is millimeter, converted inch dimensions are not necessarily exact.

- **TO-92 (Formed lead option available in Reel packing)**



SYMBOL	W	A	B	E	F
SPEC.	18.0±0.2	9.0±0.2	6.0±0.20	16.0±0.5	19.0±0.5
SYMBOL	P	P1	D	e	T
SPEC.	12.7 BSC	12.7 BSC	4.0±0.2	2.5 BSC	0.6±0.1

Note:

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